

## **LEADER TIME SRL**

## PRODUCT SPECIFICATION

## 16\*4 Characters COB LCD MODULE MODEL: LT-1604A-202 Ver:1.0

< >> Finally Specification

CUSTOMER'S APPROVAL					
CUSTOMER:					
SIG	NATURE:	DATE:			

APPROVED	PM	PD	PREPARED
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# Prepared By: LEADER TIME SRL VIA MONS. PROSDOCIMI, 27

36042 BREGANZE (VI)

I This specification is subject to change without notice. Please contact LT or its representative before designing your product based on this specification.

Doc. No.:

## **Revision Status**

VER 1.0 2010.09.02 First Issued	Version	Revise Date	Page	Content	Modified By
	VER 1.0	2010.09.02		First Issued	

## Doc. No.:

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## 1. FEATURES

The features of LCD are showed as follows

\* Display mode : STN/Yellow-Green/Transflective/Positive/anti-UV

\* Controller IC : AIP31066(English and Japanese)

\* Display format : 16X4Characters \* Interface : 4 Bit or 8 Bit MPU \* Driving Method : 1/16Duty, 1/5Bias

\* Viewing Direction : 12 O'clock

\* Backlight : LED /Yellow-Green

\*Sample NO. : EC1604A9SBY7B-B0\_01/20100830

## 2. MECHANICAL SPECIFICATIONS

Item	Specification	Unit
Module Size	87(W) x60(H) x14.5MAX(D)	mm
Viewing Area	61.8 (W) x 25.2(H)	mm
Activity Display Area	56.21(W)x20.81(H)	mm
Character Font	5x8 Dots	-
Character Size	2.96(W)x4.76(H)	mm
Character Pitch	3.55 (W) x5.35(H)	mm
Dot Size	0.56(W)x0.56(H)	mm

## 3. ELECTRICAL SPECIFICATIONS

#### 3-1 ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Item	Symbol	Min	Max	Unit
Supply Voltage For Logic	Vdd	-0.3	7.0	V
Supply Voltage For LCD Drive	$V_{LCD}$	VDD-10	V <sub>DD</sub> +0.3	V
Input Voltage	Vin	-0.3	V <sub>DD</sub> +0.3	V
Operating Temp.	Тор	-20	+70	°C
Storage Temp.	Tst	-30	+80	°C

<sup>\*.</sup> NOTE: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

## **3-2 ELECTRICAL CHARACTERISTICS**

ltem		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Logic supply Voltage		V <sub>DD</sub> – V <sub>ss</sub>		4.5	5	5.5	V
LCD Di	LCD Drive			4.0	4.3	4.6	V
Input Voltage	"H" Level	V <sub>IH</sub>	Ta = 25 °C	0.7 Vdd	-	VDD	V
	"L" Level	V <sub>IL</sub>	$V_{DD}=5V\pm10\%$	-0.3	-	0.6	V
Frame Frequency		f <sub>FLM</sub>		ı	84.7	-	Hz
Current Cons	sumption	I <sub>DD</sub>		-	1.47	-	mA

## 3-3 BACKLIGHT

3-3-1. Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Current	IF		-	-	120	mA
Reverse Voltage	VR	Ta = 25 °C	-	-	10	V
Power Dissipation	PD		-	-	1220	mW

3-3-2. Electrical-optical Characteristics

5-5-2. Liectrical-optical characteristics						
ltem	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF		4.0	4.2	4.4	V
Average Luminous Intensity	lv	If=120mA Ta = 25 °C	110	-	-	cd/m <sup>2</sup>
Peak wave length	λр	14 - 25 0	569	572	575	nm

The brightness is measured without LCD panel

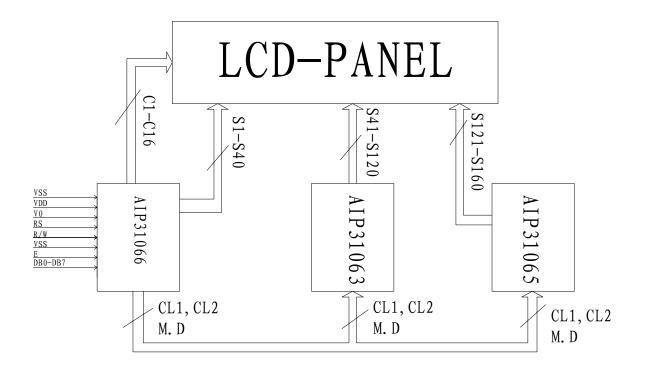
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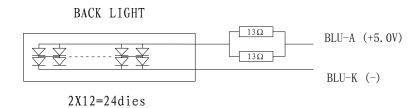
## 4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

## 4-1 INTERFACE PIN FUNCTION DESCRIPTION

PIN NO.	SYMBOL	FUNCIONS
1	VSS	Ground
2	VDD	Supply voltage for logical circuit
3	V0	Supply voltage for LCD driving
4	RS	A signal for selecting registers.
5	R/W	A signal for selecting read or write actions.1: Read, 0: Write.
6	E	Read / Write enable signal
7-14	DB0~DB7	Data Bus
15	BLU-A	Backlight (5.0V)
16	BLU-K	Backlight (-)

#### **4-2 BLOCK DIAGRAM**



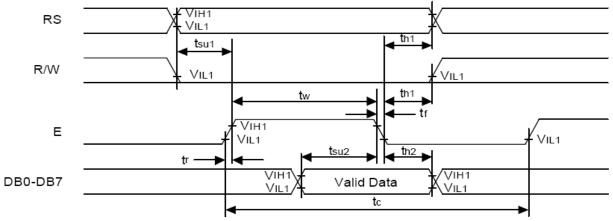


## **5. TIMING CHARACTERISTICS**

## 5 - 1 Write mode

Mode	Characteristics	Symbol	Min	Тур	Max	Unit
Write Mode	E Cycle Time	tc	500	-	_	ns
(refer to Figure-6)	E Rise/Fall Time	$t_R$ , $t_F$	-	_	20	
	E Pulse Width (High, Low)	tw	230	_	-	
	R/W and RS Setup Time	tsu1	40	-	-	
	R/W and RS Hold Time	t <sub>H1</sub>	10	_	-	
	Data Setup Time	tsu2	80	_	-	
	Data Hold Time	t <sub>H2</sub>	10	_	_	

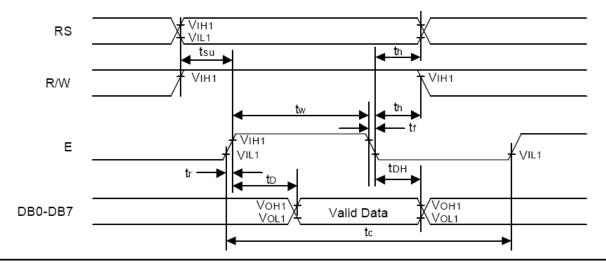
## 5-2 Write mode timing diagram



## 5.3 Read mode

Read Mode	E Cycle Time	tc	500	ı	ı	ns
(refer to Figure-7)	E Rise/Fall Time	t <sub>R</sub> , t <sub>F</sub>	_	_	20	
	E Pulse Width (High, Low)	tw	230	ı	1	
	R/W and RS Setup Time	tsu	40	-	ı	
	R/W and RS Hold Time	t <sub>H</sub>	10	1	1	
	Data Output Delay Time	tD	_	-	120	
	Data Hold Time	tDH	5	_	_	

## 5-4Read mode timimg diagram



## 6. COMMAND LIST

## **6-1 Instruction Table**

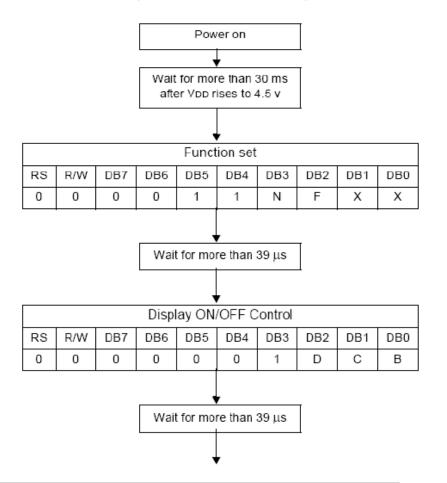
Instruction				Ins	tructi	on Co	ode				Description	Execution
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Instruction Code	time(fsoc=270)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	X	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and make shift of entire display enable.	39µs
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display(D), cursor(C), and blinking of cursor(B) on/off control bit.	39µs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	×	X	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	39µs
Function Set	0	0	0	0	1	DL	N	F	X	X	Set interface data length (DL: 4-bit/8-bit), numbers of display line (N: 1-line/2-line), display font type (F: 5 X 8 dots/ 5 X 11 dots)	39µs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39µs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39µs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0μs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43µs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43µs

NOTE: When an MPU program with checking the Busy Flag (DB7) is made, it must be necessary 1/2 fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to "LOW".

## 7. INSTRUCTION SET

## INITIALIZING BY INSTRUCTION

1) 8-bit interface mode (Condition: fosc = 270KHZ)



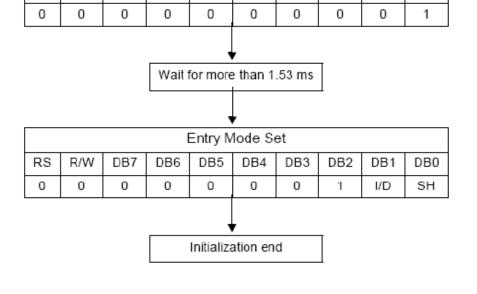
N	0	1-line mode				
- ' '	1	2-line mode				

F	0	display off
' '	1	display on

D	0	display off			
	1	display on			

С	0	cursor off		
	1	cursor on		

В	0	blink off
	1	blink on



Display Clear

DB4

DB3

DB2

DB1

DB0

DB5

RS

R/W

DB7

DB6

I/D	0	decrement mode			
	1	increment mode			

SH	0	entire shift off
0.1	1	entire shift on

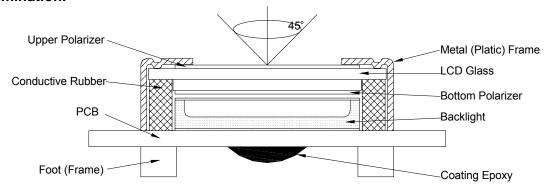
## 8. CHARACTER GENERATOR ROM

Upp # 4	00 00	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	11 00	1101	1110	1111
xxxx0000	CG RAM (1)	0001	0010	Ø	a	P	0110	F	1000	1001	1010	_	7	=	C:C	þ
xxxx0001	(2)		1	1	A	Q	a	4				7	Ŧ	4	ä	q
xxxx0010	(3)			2	В	R	b	r				1	<b>"</b> J	×	ß	8
xxxx0011	(4)		#	3	C	5	C	s			7	ゥ	Ť	ŧ	Ŵ	00
xxxx0100	(5)		\$	4	D	Ţ	d	ŧ.				I	Ļ	ţ	귂	Ω
xxxx0101	(6)		7	5	E	U	e	u				7	<del></del>	l	6	ü
xxxx0110	(7)		&	6	F	Ų	f	V			7	Ħ	_	3	ρ	Σ
xxxx0111	(8)		7	7	G	Ŵ	9	W			7	<b>‡</b>	X	<b>ラ</b>	9	π
xxxx1000	(1)		C	8	H	X	h	X			4	7	*	IJ	Ţ	X
xxxx1001	(2)		ን	9	I	Y	i	y			Ċ	<u>ተ</u>	J	ıŀ	-1	Ч
xxxx1010	(3)		*		J	Z	j	Z			I		'n	Ŀ	j	Ŧ
xxxx1011	(4)		+	;	K		k	{			7	Ħ	L		×	셔
xxxx1100	(5)		7	<		¥	1				t	Ð	Ţ	7	4	Ħ
xxxx1101	(6)		_	=	M	]	M	)			ュ	Z		1	Ł	÷
xxxx1110	(7)		•	>	N	^	n	<b>+</b>			3	Ę	4.		ñ	
xxxx1111	(8)		•	?	0	_	0	+			2	<u>y</u>	Ŧ		ő	

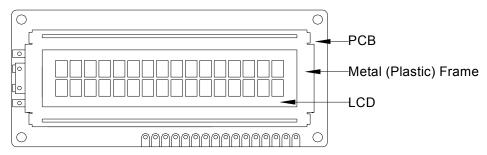
Note: The user can specify any pattern for character-generator RAM.

## 9. QUALITY SPECIFICATIONS

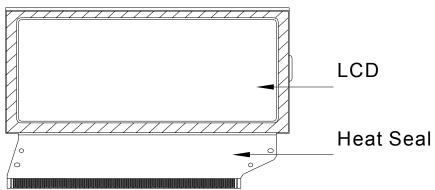
- 9 1. LCM Appearance and Electric inspection Condition
- 1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.



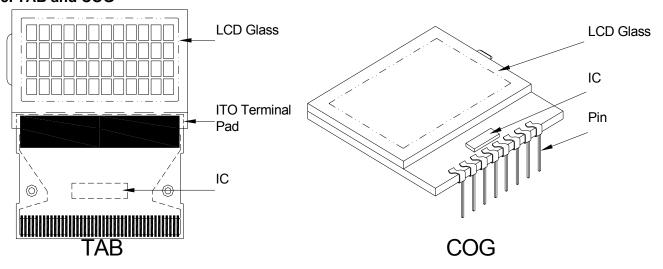
- 2. View Angle: with in 45° around perpendicular line.
- 9- 2. Definition
- 1. COB



2. Heat Seal



3. TAB and COG



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## 9-3. Sampling Plan and Acceptance

1.Sampling Plan

MIL - STD - 105E (  $\parallel$  ) ordinary single inspection is used.

2.Acceptance

Major defect: AQL = 0.25%Minor defect: AQL = 0.65%

#### 9-4. Criteria

## 1.COB

Defect	Inspection Item	Inspection Standards	
Major	PCB copper flakes peeling off	Any copper flake in viewing Area should be greater than 1.0mm <sup>2</sup>	Reject
Major	Height of coating epoxy	Exceed the dimension of drawing	Reject
Major	Void or hole of coating epoxy	Expose bonding wire or IC	Reject
Major	PCB cutting defect	Exceed the dimension of drawing	Reject

#### 2.SMT

Defect	Inspection Item	Inspection Standa	ards
Minor	Component marking not readable		Reject
Minor	Component height	Exceed the dimension Of drawing	Reject
Major	Component solder defect (missing, extra, wrong component or wrong orientation		Reject
Minor	Component position shift  component soldering pad  X  D  Y  Y	X < 3/4Z Y > 1/3D	Reject
Minor	Component tilt component  soldering pad	Y > 1/3D	Reject
Minor	Insufficient solder component PAD ← PCB	θ <u>&lt;</u> 20°	Reject

## 3. Metal (Plastic) Frame

Defect	Inspection Item	Inspection Standards				
Major	Crack / breakage	Any	Reject			
		W	L	Acceptable of Scratch		
		w<0.1mm	Any	Ignore		
		0.1 <u>&lt;</u> w<0.2mm	L <u>&lt;</u> 5.0mm	2		
Minor	Frame Scratch	0.2 <u>&lt;</u> w<0.3mm	L <u>&lt;</u> 3.0mm	1		
		w <u>&gt;</u> 0.3mm	Any	0		
		with distance g	e to scratch lines e of frame (not			
				Acceptable of Dents / Pricks		
		Φ <u>&lt;</u>	2			
	Frame Dent , Prick	1.0<	1			
Minor	$\Phi = \frac{L + W}{2}$	1.5	0			
	2	Note: 1. Above criteria applicable to any two dents / pricks with distance greater than 5mm 2. Dent / prick on the back side of frame (not visible) can be ignored				
Minor	Frame Deformation	Exceed the dimension of drawing				
Minor	Metal Frame Oxidation	Any rust				

## 4. Flexible Film Connector (FFC)

4. Flexible F		ection Item	Inspection Standards			
Minor	Tilted soldering		Within the angle +5°	Acceptable		
Minor	Uneven solder joint /bump			Reject		
			Expose the conductive line	Reject		
Minor	Hole	$\Phi = \frac{L + W}{2}$	Φ > 1.0mm	Reject		
Minor	Position shift		Y > 1/3D	Reject		
IVIIIIOI			X > 1/2Z	Reject		

## 5. Screw

U. U. I.							
Defect Inspection Item		Inspection Standards					
Major	Screw missing/loosen		Reject				
Minor	Screw oxidation	Any rust	Reject				
Minor	Screw deformation	Difficult to accept screw driver	Reject				

## 6. Heatseal 、TCP 、FPC

Defect	Inspection Item	Inspection Standards	
Major	Scratch expose conductive layer		Reject
Minor	HS Hole $\Phi = \frac{L + W}{2}$	Ф> 0.5mm	Reject
Major	Adhesion strength	Less than the specification	Reject
Minor	Position shift	Y > 1/3D	Reject
IVIII IOI	* ************************************	X > 1/2Z	Reject
Major	Conductive line break		Reject

7. LED Backing Protective Film and Others

LED Backing Protective Film and Others						
Defect	Inspection Item	Inspection Standards				
		Acceptable number of units				
		Ф <u>&lt;</u> 0.10mm	ignore			
		0.10<Φ <u>&lt;</u> 0.15mm	2			
Minor	LED dirty, prick	0.15<Φ <u>&lt;</u> 0.2mm	1			
		Ф>0.2mm	0			
		The distance between any two spots should be ≥5mm Any spot/dot/void outside of viewing area is acceptable				
Minor	Protective film tilt	Not fully cover LCD Re				
Major	COG coating	Not fully cover ITO circuit F				

8. Electric Inspection

Defect	Inspection Item	Inspection Standards	
Major	Short		Reject
Major	Open		Reject

9. Inspection Specification of LCD

Inspection Specification of LCD									
Defect	Insp	ect Item		Inspection Standards					
		* Glass Scratch	W	W <u>&lt;</u> 0.03		0.0			N>0.05
Minor	Lincar Defect	* Polarizer Scratch	ACC.	<u> </u>	_<5		L<3		Any
	Linear Defect	<ul> <li>Fiber and Linear material</li> </ul>	NO.	1			1		Reject
		materiai	Note	L is the length and W is the width of the de			efect		
		<ul> <li>Foreign material</li> </ul>		Ф <u>&lt;</u> 0.1			15 0.15<Ф <u>&lt;</u> 0.2		Ф>0.2
	Black Spot and	between glass and polarizer or glass		3EA / 100mm²	2		1		0
Minor		and glass  * Polarizer hole or protuberance by external force	Note	Φ is the average diameter of the defect.  Distance between two defects > 10mm.					
		* Unobvious	Ф	Ф<0.3		0.3	0.3<Φ <u>&lt;</u> 0.5 0.		.5<Ф
	White Spot	transparent foreign material between		3EA / 1	100mm²		1	1	
Minor	and Bubble in polarizer	glass and glass or glass and polarizer * Air protuberance between polarizer and glass		Φ is the average diameter of the defect. Distance between two defects > 10mm.					
	Segment Defect	W	Φ	Ф <u>&lt;</u> 0.10	0.10<Ф<	0.20	0.20<Φ <u>&lt;</u>	0.25	Ф>0.25
			ACC. NO.	3EA / 100mm²	2		1		0
Minor				W is more than 1/2 segment width			Reject		
		W	Note	$\Phi = \frac{L + W}{2}$ Distance between two defect is 10mm					
			Ф	Ф <u>&lt;</u> 0.10	0.10<Ф<	0.20	0.20<Ф<	0.25	Ф>0.25
	Protuberant Segment	ratuborant W		Glue	W <u>&lt;</u> 1/2 Seg W <u>&lt;</u> 1/2 W≤0.2 W≤0			Ignore	
Minor			ACC. NO.	3EA / 100mm²	2	<del></del>	1	<del></del>	0
	Assembly Mis-alignment			1. Segment					
			Е	B <u>&lt;</u> 0.4mm 0		_		1.0mm	
Minor			B-	A B	A B-A<1/2B		B-A<0.2 B-A		\<0.25
				dge Acceptable Acceptable Accep			eptable		
			2. Dot Matrix					_	
			Deformation>2°				Reject		
Minor	Stain on LCD Panel Surface		Accept when stains can be wiped lightly with a soft cloth or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot"						

## 10. RELIABILITY

NO.	Item	Condition	Criterion		
1	High Temperature Operating	70℃, 96Hrs			
2	Low Temperature Operating	-20℃, 96Hrs			
3	High Humidity	60℃, 90%RH, 96Hrs			
4	High Temperature Storage	80℃, 96Hrs			
5	Low Temperature Storage	-30℃, 96Hrs	No defect in cosmetic and		
		Random wave	operational function allowable.		
6	Vibration	10 ~ 100Hz	Total current Consumption should be below double of initial value.		
	Vibration	Acceleration: 2g			
		2 Hrs per direction(X,Y,Z)			
		-20℃ to 25℃ to 70℃			
7	Thermal Shock	(60Min) (5Min) (60Min)			
		16Cycles			
8	ESD Testing	Contract Discharge Voltage: +1 ~ 5kV and –1 ~ –5kV	There will be discharged ten times at every discharging		
	LOD Teating	Air Discharge Voltage: +1 ~ 8kV and –1 ~ -8kV	voltage cycle. The voltage gap is 1kV.		

Note: 1) Above conditions are suitable for our company standard products.

2) For restrict products, the test conditions listed as above must be revised.

## 11. HANDLING PRECAUTION

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers, which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Tricolor trifler thane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Kenton
- Aromatics

#### (3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

#### (4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

#### (5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's .which will come back in the specified operating temperature range.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- -A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

#### (6) Storage

In the case of storing for a long period of time, (For years) for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

#### (7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol. Which should be burned up later. When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

## 12. OUTLINE DIMENSION

